

Brainware University
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## BRAINWARE UNIVERSITY

Term End Examination 2021 - 22
Programme – Diploma in Electrical Engineering
Course Name – Basic Electronics
Course Code - DEE303
(Semester III)

Time: 1 Hr.15 Min.

Full Marks: 60

[The figure in the margin indicates full marks.]

Group-A Choose the correct alternative from the following: (Multiple Choice Type Question) 1 x 60=60 (1) A diode whose terminal characteristics are related as  $I = I_s e^{V/V} T(Is is the reverse satur)$ ation current, and  $V_T$  is the thermal voltage(=25mV)) is biased at i = 2mA. Its dynamic a) 25 ohm b) 12.5 ohm c) 50 ohm (2) If Zener breakdown voltage is  $V_z$  while avalanche break down voltage is  $V_a$  then d) 100 ohm a) Vz greater than Va b) Vz less than Va c)  $V_z = V_a$ d) None of these (3) For a p-n-p transistor in CE mode,  $\beta$ =100, then the value of  $\alpha$  of the transistor is b) 0.099 c) 9.9 d) 99 (4) The junction capacitance of a p-n diode is used in a) Varactor diode b) Photo diode c) Zener diode d) Tunnel diode (5) If the cut-in voltage of a Ge p-n diode is  $V_{r1}$  and that of Si p-n diode is  $V_{r2}$  then a)  $V_{r1} = V_{r2}$ b) V<sub>r1</sub> greater than V<sub>r2</sub> c) V<sub>r1</sub> less than V<sub>r2</sub> d) none of these (6) In active region of a transistor a) Both emitter and collector junctions are reve b) Both emitter and collector junctions are reve rse biased c) Emitter junction is forward biased and collec d) None of these

tor junction is reverse biased	
or it to lation layers are	a together
a) Touching each other	
c) Far apart	d) None of these
(8) Which of the following devices is expected to have	ve the highest input
a) MOSFET	b) BJT
c) JFET	d) none of these
(9) The donor impurities	Lales
a) Generate electrons	b) Generate holes
	d) All of these
c) Generate hole and electrons (10) Which of the following is method to model a dic	ode's forward characteristics
a) Iteration method	b) Graphical method
a) Constant-voltage drop model	d) All of the mentioned
c) Constant-voltage drop model (11) If the positive terminal of the battery is connected nown as	ed to the anode of the diode, then
nown as	
a) Forward biased	b) Reverse biased
c) Fauilibrium	d) Schottky barrier
c) Equilibrium  (12) If the voltage of the potential barrier is V <sub>0</sub> . A voltage of the potential barrier is V <sub>0</sub> .	oltage V is applied to the input,
moment will the barrier disappear?	
a) V less than V <sub>0</sub>	b) $V = V_0$
	d) V much less than V <sub>0</sub>
c) V greater than V <sub>0</sub>	
(13) The current in the diode is contributed by	b) Minority carriers only
a) Majority carriers only	d) None of these
c) Both majority and minority carriers	ance of a Zener diode?
(14) Which of the following is true about the resista	b) It has dynamic resistance
a) It has an incremental resistance	b) it has -y
c) The value of the resistance is the inverse of the slope of the i-v characteristics of the Zene	d) All of the mentioned
r diode (15) In Zener diode, for currents greater than the ki	nee current, the V-I curve is almost
a) Almost a straight line parallel to y-axis	
c) Equally inclined to both the axes with a posit	d) Equally inclined to both the axes with a negative slope
ive slope (16) The advantages of a junction transistor over t	he vacuum triode is
(16) The advantages of a junction transition over	b) High efficiency
a) High power consumption	d) Less doping
c) Large size	
(17) In an NPN transistor, the arrow is pointed to	varus
a) The collector	b) The base
a) The emitter	d) Depends on the configuration
(18) In the operation of an NPN transistor, the ele	ctrons cross which region?
a) Emitter region	<ul> <li>b) The region where there is high depletion</li> </ul>
c) The region where there is low depletion	d) P type base region
(19) When does the transistor act like an open sw	ritch?
(19) When does the transistor act like all open sw	

a) Cut off region	b) Active region
c) Saturated region	d) None of these
(20) The emitter current consists of	
a) Carriers passing from collector to emitter     c) Carriers passing from emitter to base	b) Carriers passing from base to collector d) None of these
(21) The AC current gain in a common base configura	ration is
a) -ΔIC/ΔIE	b) ΔIC/ΔIE
c) ΔIE/ΔIC	d) -ΔΙΕ/ΔΙC
(22) The base current amplification factor β is given	and the second of the second property and the second of th
a) IC/IB	
c) IE/IB	b) IB/IC d) IB/IE
(23) The application of a CC configured transistor is	d) IB/IE
a) voltage multiplier	b) Level shifter
c) Rectification	d) Impedance matching
(24) The input resistance of transistor is given by	and the second second second second second second second
a) ΔVCE/ΔΙΒ	b) AVBE/AIB
c) AVBE/AIC	d) AVBE/AIE
(25) The electron-hole pairs in semi-conductor are g	generated by
a) Thermal agitation	b) Doping
c) Recombination	d) Ionisation
(26) Recombination happens when	The second secon
a) A valance electron jumps to conduction band from valence band	b) An electron falls into a hole
c) A positive ion and a negative ion bind togeth er	d) All of these
(27) The most commonly used semiconductor mate es is	rial in manufacturing of electronic devic
a) Silicon	b) Boron
c) Germanium	d) Gallium arsenide
(28) When trivalent impurities just like aluminum a becomes a/an	
a) P-type semiconductor	b) N-type semiconductor
c) PN-junction	d) All of these
(29) In an N-type semiconductor, the position of th	•
a) In the middle of the energy gap	
c) Below the Centre of the energy gap	<ul><li>b) Above the center of the energy gap</li><li>d) Anywhere in the energy gap</li></ul>
(30) The unit of mobility of electrons is	d) Anywhere in the energy gap
a) cm <sup>2</sup> /V-s	b) am A/ a
	b) cm/V-s
c) m <sup>2</sup> /s	d) cm <sup>2</sup> /V
(31) The depletion region of a PN-junction is form	ed

<ul><li>b) When forward-bias voltage is applied</li><li>d) All of these</li></ul>
d) All of these
The state of the s
b) 0.5V
d) 0.8V
d) 0.8V and thus it conducts. Then the voltage dro
b) 0.5V
d) 0.8V
ction diode is doubled for every
b) 50c increase in temperature
d) 10c increase in temperature
b) Decrease in voltage
d) All of these
b) To acts as a constant resistance
d) All of these
oped compared to base and collector regio
b) Collect the charge carriers
d) Provide minimum resistance
Ico
er b) Becomes doubled for each 50c rise in temper
p d) Becomes doubled for each 200c rise in temp erature
tion is less dependent on temperature?
b) Common collector
d) All of these
ealy should have an output voltage equal to
b) Negative supply voltage
d) CMRR
gain of 200,000. Its output exhibits saturatio of the amplifier is
b) 50 microvolt
d) 10V
01 and a differential mode gain of 10 <sup>5</sup> . Its C
b) 10 <sup>-3</sup>
d) 10 <sup>7</sup>
mon mode voltage gain of a differential amp

a) 23dB	b) 25dB
c) 46dB	d) 50dB
(44) The output of a certain op-amp circuit chang	es by 20 V in 4 microsecond. Its slew rate
a) 50 V/microsecond	b) 500 mV/microsecond
c) 5 V/microsecond	d) 500 V/microsecond
(45) In a single stage R-C coupled amplifier, what nd upper 3 dB frequencies respectively?	
a) 45 <sup>0</sup> , 225 <sup>0</sup>	b) 45 <sup>0</sup> , 135 <sup>0</sup>
c) $90^0$ , $180^0$	d) 45 <sup>0</sup> , 180 <sup>0</sup>
(46) The common mode rejection ratio of an OP A	
a) Much smaller than unity	b) Much larger than unity
c) unity	d) none of these
(47) An ideal OP AMP has	
a) Infinite input impedance	b) Zero output impedance
c) Infinite voltage gain	d) All of these
(48) An OPAMP has	
a) Equal input and output resistance	b) Low input resistance and a large output resi stance
c) Large input resistance and low output resista nce	d) None of these.
(49) The number of pins of the IC741 OP-AMP is	
a) 10	b) 8
c) 12	d) 16
(50) If the input is a rectangular pulse, the output of	an integrator is
a) sine wave	b) square wave
c) ramp	d) rectangular wave
(51) The non-inverting amplifier has a	
a) large closed loop voltage gain	b) small open loop voltage gain
c) large closed loop input impedance	d) large closed loop output impedance
52) The input resistance of 741 OPAMP is	
a) 100 ohm	b) approx. 20 Kilo ohm
c) approx. 2 Mega ohm	d) 20 Mega ohm
3) When in a negative scaler, both R1 and Rf are re	educed to zero, the circuit functions as
a) zero	b) small
c) large	d) infinite
An electron device means the device in which the hrough	
a) A gas	b) Vacuum
c) A semiconductor	d) A gas, semiconductor or vacuum
i) In a semiconductor diode schematic symbol, arro	
a) N-type material	b) P-type material
c) Both p and n-type material	
c) both p and n-type material	d) None of these

(56) Avalanche multiplication	
a) Disruption of covalent bonds occurs by colli	b) Direct rupture bonds
c) Both (Disruption of covalent bonds occurs by collision) and (Direct rupture bonds)	d) None of these
(57) In p-n junction, the avalanche breakdown voltage	
a) Decreases	
	b) Increases
parameters are independent	d) Decreases or increases in abrupt p-n junction
(58) Consider the following statements for a p-n junct. ii) Depletion layer width decreases with forward, se, saturation current increases with increasing twen above are corrects?	ard hiscing (ii) In the reverse hiscing ca
a) i), ii) and iii)	b) i) and ii) only
c) ii) and iii) only	d) i) and iii) only
(59) The doping concentration on the n-side of a p-n of the following will get affected?	
a) Width of the depletion region on n-side.	b) Width of the depletion region on p-side.
c) Width of the depletion region on both sides.	d) No change in width of depletion regions.
(60) Electron mobility and lifetime in a semiconducto 0.36 m2/(Vs) and 340 μs. the diffusion length is	
a) 3.13 mm	b) 1.77 mm
c) 3.55 mm	d) 3.13 cm